

6 Lake Street, Lawrence, MA 01841 1-800-446-1158 / (978) 620-2600 / Fax: (978) 689-0803

Website: http://www.microsemi.com

RADIATION HARDENED PNP SILICON SWITCHING TRANSISTOR

Qualified per MIL-PRF-19500/357

| 2N3634 | 2N3635 | 2N3636 | 2N3637 |
|----------|----------|----------|----------|
| 2N3634L | 2N3635L | 2N3636L | 2N3637L |
| 2N3634UB | 2N3635UB | 2N3636UB | 2N3637UB |

LEVELS

JANSM – 3K Rads (Si) JANSD – 10K Rads (Si) JANSP – 30K Rads (Si) JANSL – 50K Rads (Si) JANSR – 100K Rads (Si)

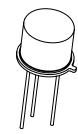
ABSOLUTE MAXIMUM RATINGS ($T_C = +25$ °C unless otherwise noted)

| Parameters / Test Conditions | Symbol | 2N3634* 2N3635* | 2N3636* 2N3637* | Unit |
|--|-------------------|--------------------|--------------------|-------------|
| Collector-Emitter Voltage | V_{CEO} | 140 | 175 | Vdc |
| Collector-Base Voltage | V_{CBO} | 140 | 175 | Vdc |
| Emitter-Base Voltage | $V_{\rm EBO}$ | 5.0 | 5.0 | Vdc |
| Collector Current | I_{C} | 1.0 | 1.0 | Adc |
| Total Power Dissipation \textcircled{a} $T_A = +25^{\circ}C$ \textcircled{a} $T_C = +25^{\circ}C$ UB: \textcircled{a} $T_C = +25^{\circ}C$ | P _T ** | 1.0 5.0 1.5 | | W W W |
| Operating & Storage Junction Temperature Range | T_{J}, T_{stg} | -65 to +200 | | °C |

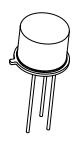
^{*} Electrical characteristics for "L" suffix devices are identical to the "non L" corresponding devices.

ELECTRICAL CHARACTERISTICS ($T_A = +25$ °C, unless otherwise noted)

| Parameters / Test Co | Symbol | Min. | Max. | Unit | | | |
|---|----------------------------------|----------------------|------------|-----------------|----------------------|--|--|
| OFF CHARACTERTICS | | | | | | | |
| Collector-Emitter Breakdown Vo | ltage | | | | | | |
| $I_C = 10$ mAdc | 2N3634, 2N3635 2N3636, 2N3637 | V _{(BR)CEO} | 140 175 | | Vdc | | |
| | 2N3634, 2N3635 2N3636, 2N3637 | I_{CBO} | | 100 10 10 | ηAdc μAdc μAdc | | |
| Emitter-Base Cutoff Current $V_{EB} = 3.0 \text{Vdc}$ $V_{EB} = 5.0 \text{Vdc}$ | | I_{EBO} | | 50 10 | ηAdc μAdc | | |
| | | I_{CEO} | | 10 | μAdc | | |



TO-5* 2N3634L, 2N3635L 2N3636L, 2N3637L



TO-39* (TO-205AD) 2N3634, 2N3635 2N3636, 2N3637



3 PIN 2N3634UB, 2N3635UB 2N3636UB, 2N3637UB

T4-LDS-0065 Rev. 2 (100377) Page 1 of 5

^{**} Consult 19500/357 for De-Rating curves.



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ELECTRICAL CHARACTERISTICS ($T_A = +25$ °C, unless otherwise noted)

| Parameters / Test Conditions | | Symbol | Min. | Max. | Unit |
|---|----------------|----------------------|------------------------------|------------|------|
| ON CHARACTERISTICS (1) | | | | | |
| $\begin{split} & Forward\text{-}Current \ Transfer \ Ratio \\ & I_C = 0.1 \text{mAdc}, \ V_{CE} = 10 \text{Vdc} \\ & I_C = 1.0 \text{mAdc}, \ V_{CE} = 10 \text{Vdc} \\ & I_C = 10 \text{mAdc}, \ V_{CE} = 10 \text{Vdc} \\ & I_C = 50 \text{mAdc}, \ V_{CE} = 10 \text{Vdc} \\ & I_C = 150 \text{mAdc}, \ V_{CE} = 10 \text{Vdc} \\ \end{split}$ | 2N3634, 2N3636 | $h_{ m FE}$ | 25 45 50 50 30 | 150 | |
| $\begin{split} I_{C} &= 0.1 \text{mAdc}, V_{CE} = 10 \text{Vdc} \\ I_{C} &= 1.0 \text{mAdc}, V_{CE} = 10 \text{Vdc} \\ I_{C} &= 10 \text{mAdc}, V_{CE} = 10 \text{Vdc} \\ I_{C} &= 50 \text{mAdc}, V_{CE} = 10 \text{Vdc} \\ I_{C} &= 150 \text{mAdc}, V_{CE} = 10 \text{Vdc} \end{split}$ | 2N3635, 2N3637 | | 55 90 100 100 60 | 300 | |
| $\begin{split} & \text{Collector-Emitter Saturation Voltage} \\ & I_C = 10 \text{mAdc}, I_B = 1.0 \text{mAdc} \\ & I_C = 50 \text{mAdc}, I_B = 5.0 \text{mAdc} \end{split}$ | | V _{CE(sat)} | | 0.3 0.6 | Vdc |
| $\begin{aligned} &\text{Base-Emitter Saturation Voltage} \\ &\text{I}_{\text{C}} = 10\text{mAdc}, \text{I}_{\text{B}} = 1.0\text{mAdc} \\ &\text{I}_{\text{C}} = 50\text{mAdc}, \text{I}_{\text{B}} = 5.0\text{mAdc} \end{aligned}$ | | V _{BE(sat)} | 0.65 | 0.8 0.9 | Vdc |

DYNAMIC CHARACTERISTICS

| Forward Current Transfer Ratio | | | | | |
|--|--------------------------------------|------------------------------|------------|-------------------|----|
| $I_C = 30 \text{mAdc}, V_{CE} = 30 \text{Vdc}, f = 100 \text{MHz}$ | 2N3634, 2N3636 2N3635, 2N3637 | $ \mathbf{h}_{\mathrm{fe}} $ | 1.5 2.0 | 8.0 8.5 | |
| Forward Current Transfer Ratio | | | | | |
| $I_C = 10 \text{mAdc}, V_{CE} = 10 \text{Vdc}, f = 1.0 \text{kHz}$ | 2N3634, 2N3636 2N3635, 2N3637 | h_{fe} | 40 80 | 160 320 | |
| Small-Signal Short-Circuit Input Impedance | 2 | | | | |
| $I_C = 10 \text{mAdc}, V_{CE} = 10 \text{Vdc}, f = 1.0 \text{kHz}$ | 2N3634, 2N3636 2N3635, 2N3637 | h _{ie} | 100 200 | 600 1200 | Ω |
| Small-Signal Open-Circuit Input Impedance | e | | | | |
| $I_C = 10 \text{mAdc}, V_{CE} = 10 \text{Vdc}, f = 1.0 \text{kHz}$ | | h _{oe} | | 200 | μs |
| Output Capacitance | | | | | |
| $V_{CB} = 20 \text{Vdc}, I_E = 0, 100 \text{ kHz} \le f \le 1.0 \text{MHz}$ | | C_{obo} | | 10 | pF |
| Input Capacitance | | | | | |
| $V_{EB} = 1.0 \text{Vdc}, I_{C} = 0, 100 \text{ kHz} \le f \le 1.0 \text{MHz}$ | | C_{ibo} | | 75 | pF |
| Noise Figure | | | | | |
| $V_{CE} = 10 \text{Vdc}, I_{C} = 0.5 \text{mAdc}, R_{g} = 1.0 \text{k}\Omega$ | f = 100Hz f = 1.0kHz f = 10kHz | NF | | 5.0 3.0 3.0 | dB |

(1) Pulse Test: Pulse Width = $300\mu s$, Duty Cycle $\leq 2.0\%$

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SAFE OPERATING AREA

DC Tests

 $T_C = 25$ °C, 1 Cycle, t = 1.0s

Test 1

 $V_{CE} = 100 \text{Vdc}, I_C = 30 \text{mAdc}$

2N3634, 2N3635 2N3636, 2N3637

 $V_{CE} = 130 \text{Vdc}, I_C = 20 \text{mAdc}$

Test 2

 $V_{CE} = 50 \text{Vdc}, I_C = 95 \text{mAdc}$

Test 3

 $V_{CE} = 5.0 Vdc, I_{C} = 1.0 Adc$

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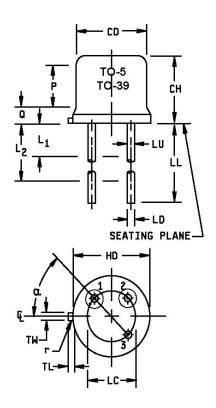


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PACKAGE DIMENSIONS



| | Dimensions | | | | |
|--------|------------|-------------|--------------|-------|-------|
| Ltr | Inches | | Millimeters | | Notes |
| | Min | Max | Min | Max | |
| CD | .305 | .335 | 7.75 | 8.51 | |
| СН | .240 | .260 | 6.10 | 6.60 | |
| HD | .335 | .370 | 8.51 | 9.40 | |
| LC | .200 | TYP | 5.08 | TYP | 7 |
| LD | .016 | .021 | 0.41 | 0.53 | 6 |
| LL | | See notes ' | 7, 9, and 10 | | |
| LU | .016 | .019 | 0.41 | 0.48 | 7 |
| L1 | | 050 | | 1.27 | 7 |
| L2 | .250 | | 6.35 | | 7 |
| P | .100 | | 2.54 | | 5 |
| Q | | .050 | | 1.27 | |
| r | | .010 | | 0.254 | 8 |
| TL | .029 | .045 | 0.74 | 1.14 | 4 |
| TW | .028 | .034 | 0.71 | 0.86 | 3 |
| α | 45° TP | | 45° TP | | 6 |
| Term 1 | Emitter | | | | |
| Term 2 | Base | | | | |
| Term 3 | Collector | | | | |

NOTES:

- 1. Dimensions are in inches.
- 2. Millimeters are given for general information only.
- 3. Beyond r maximum, TW must be held to a minimum length of .021 inch (0.53 mm).
- 4. TL measured from maximum HD.
- 5. CD shall not vary more than $\pm .010$ inch (0.25 mm) in zone P. This zone is controlled for automatic handling.
- 6. Leads at gauge plane .054 .055 inch (1.37 1.40 mm) below seating plane shall be within .007 inch (0.18 mm) radius of true position (TP) at a maximum material condition (MMC) relative to the tab at MMC. The device may be measured by direct methods or by gauge and gauging procedure.
- 7. LU applies between L1 and L2. LD applies between L2 and L minimum. Diameter is uncontrolled in L1 and beyond LL minimum.
- 8. r (radius) applies to both inside corners of tab.
- 9. For transistor types 2N3634 through 2N3637, LL is .500 inch (12.70 mm) minimum, and .750 inch (19.05 mm) maximum (TO-39).
- 10. For transistor types 2N3634L through 2N3637L, LL is 1.500 inches (38.10 mm) minimum, and 1.750 inches (44.45 mm) maximum (TO-5).
- 11. In accordance with ASME Y14.5M, diameters are equivalent to ϕx symbology.

FIGURE 1: Physical dimensions (TO-5 and TO-39)

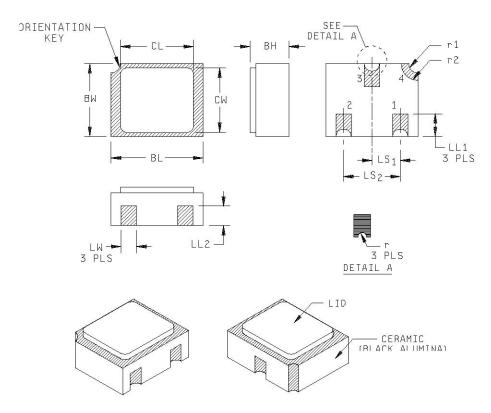
T4-LDS-0065 Rev. 2 (100377) Page 4 of 5



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NOTES:

- 1. Dimensions are in inches.
- 2. Millimeters are given for general information only.
- 3. Hatched areas on package denote metallized areas.
- 4. Pad 1 = Base, Pad 2 = Emitter, Pad 3 = Collector, Pad 4 = Shielding connected to the lid.
- 5. In accordance with ASME Y14.5M, diameters are equivalent to φx symbology

| | Dimensions | | | | |
|--------|------------|------|-------------|------|-------|
| Ltr In | | hes | Millimeters | | Notes |
| | Min | Max | Min | Max | |
| BH | .046 | .056 | 1.17 | 1.42 | |
| BL | .115 | .128 | 2.92 | 3.25 | |
| BW | .085 | .108 | 2.16 | 2.74 | |
| CL | | .128 | | 3.25 | |
| CW | | .108 | | 2.74 | |
| LL1 | .022 | .038 | 0.56 | 0.96 | |
| LL2 | .017 | .035 | 0.43 | 0.89 | |
| LS1 | .036 | .040 | 0.91 | 1.02 | |
| LS2 | .071 | .079 | 1.81 | 2.01 | |
| LW | .016 | .024 | 0.41 | 0.61 | |
| r | | .008 | | .203 | |
| r1 | | .012 | | .305 | |
| r2 | | .022 | | .559 | |

FIGURE 2: Physical dimensions, surface mount 2N3634UB through 2N3637UB (UB version).

T4-LDS-0065 Rev. 2 (100377) Page 5 of 5